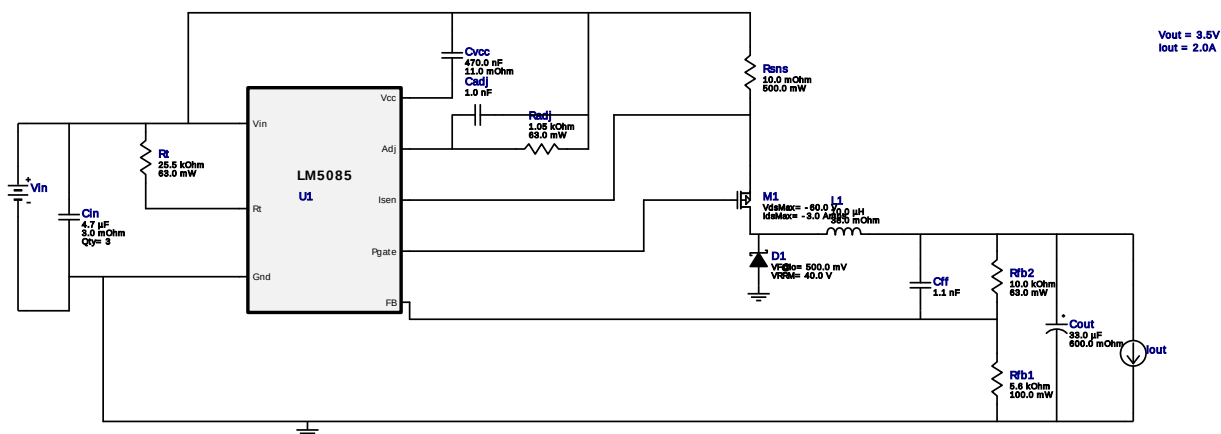


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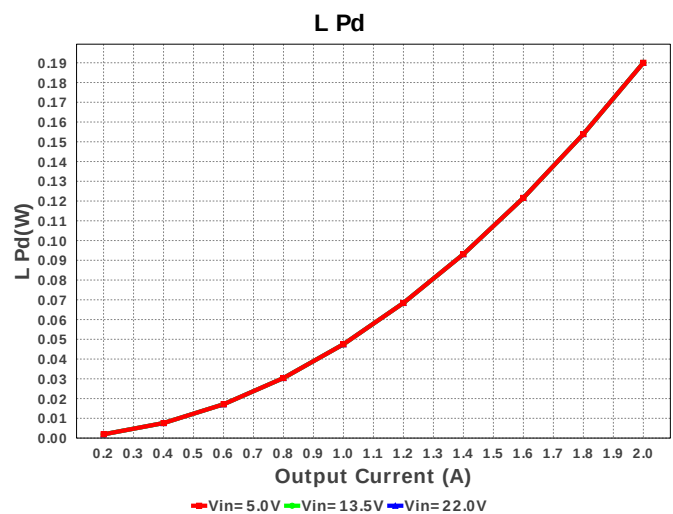
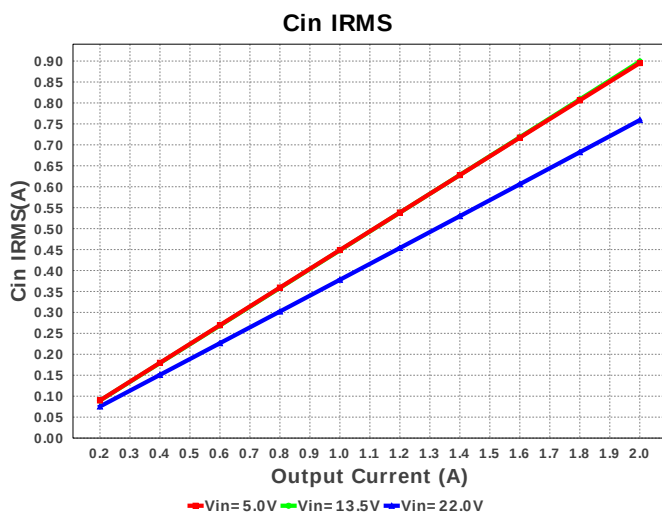
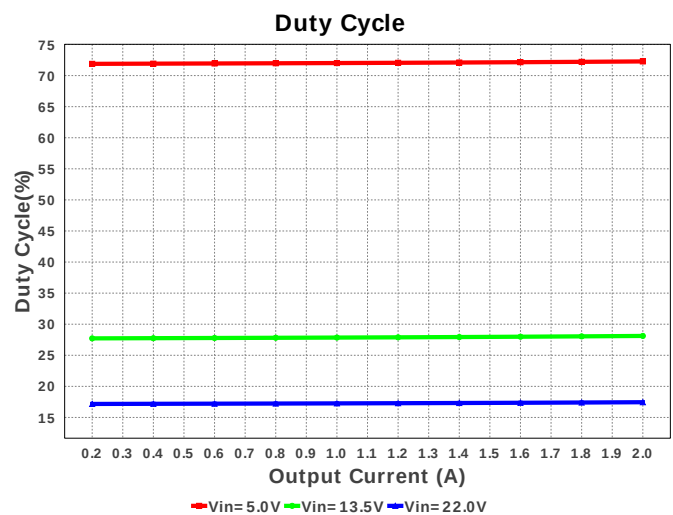
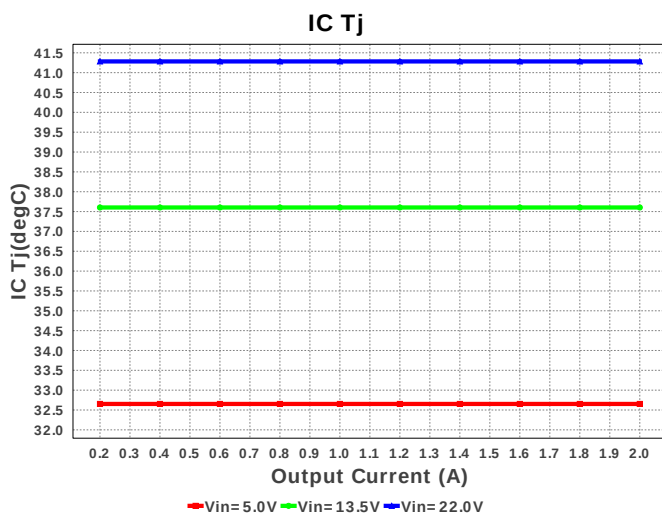
Design : 4757049/1 LM5085MY/NOPB
LM5085MY/NOPB 5.0V-22.0V to 3.50V @ 2.0A

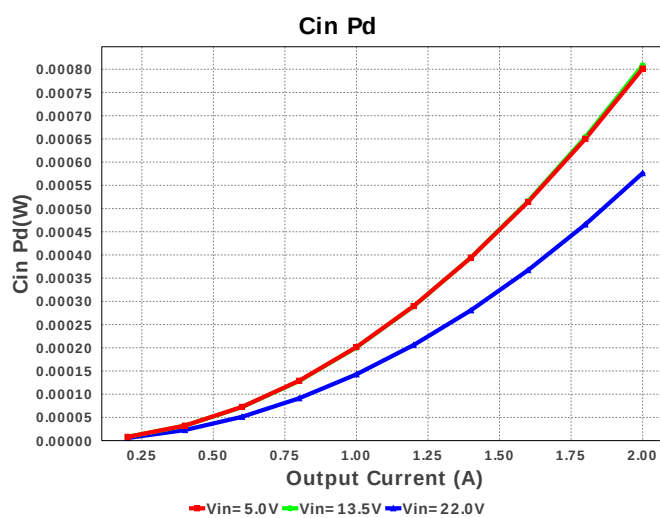
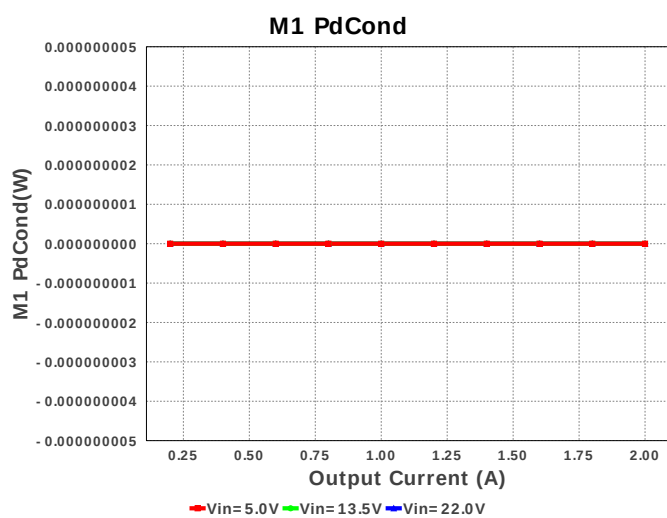
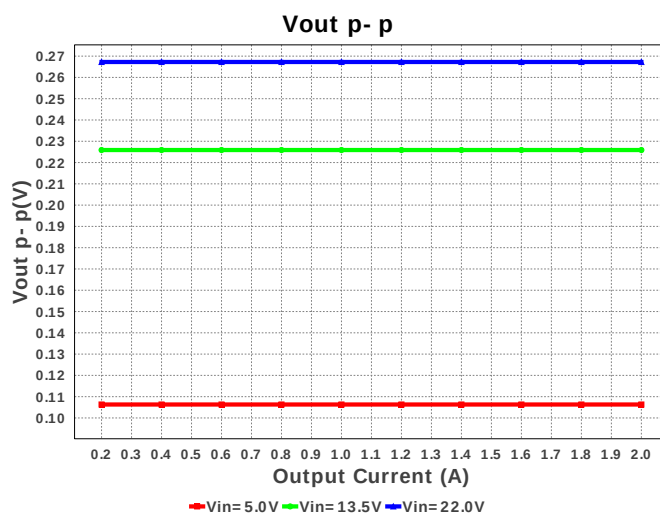
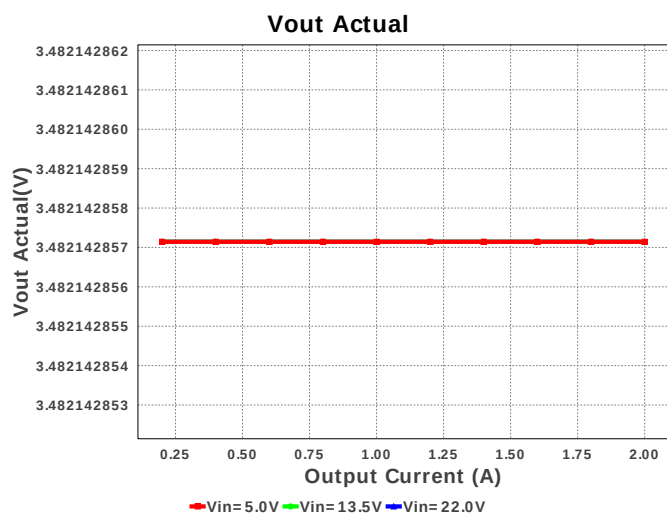
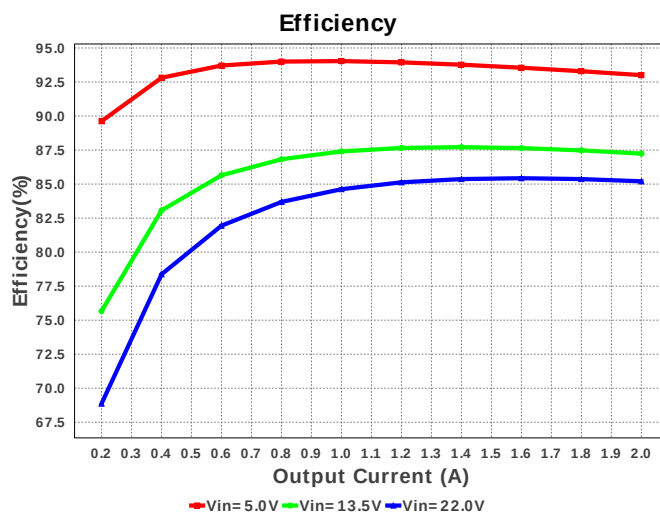
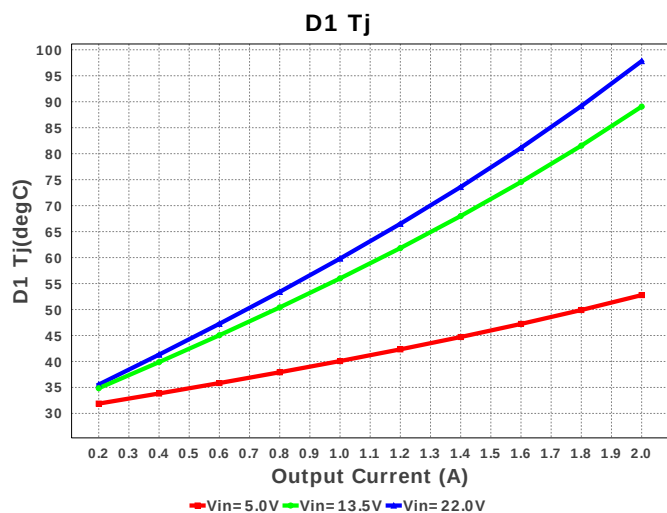


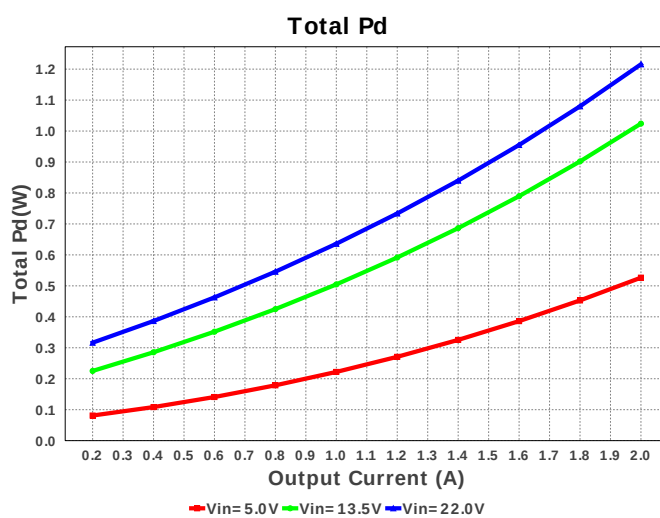
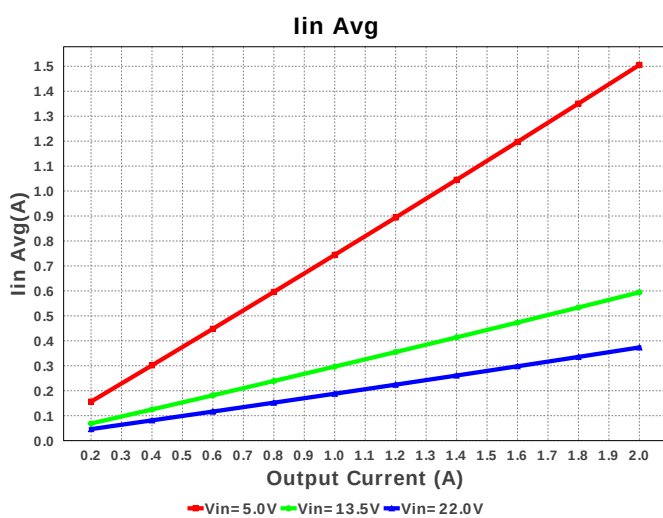
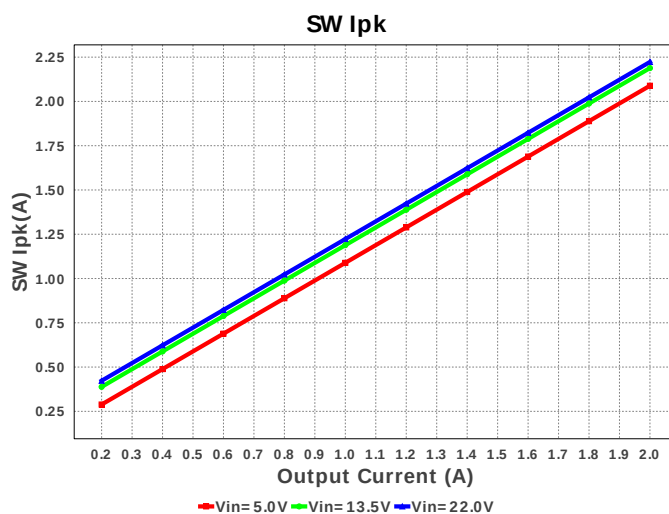
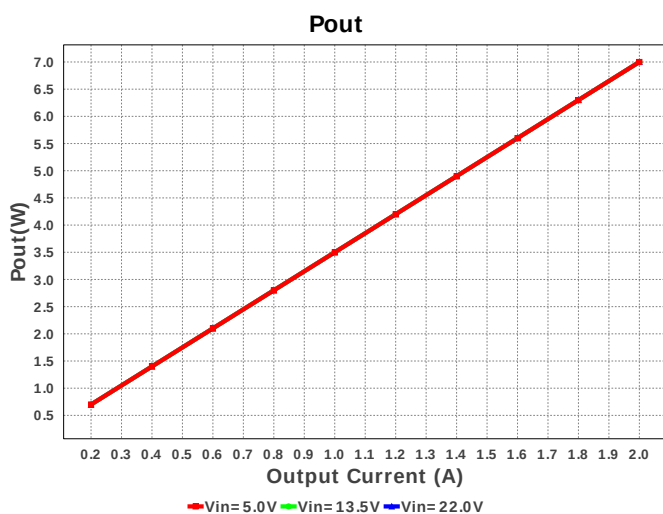
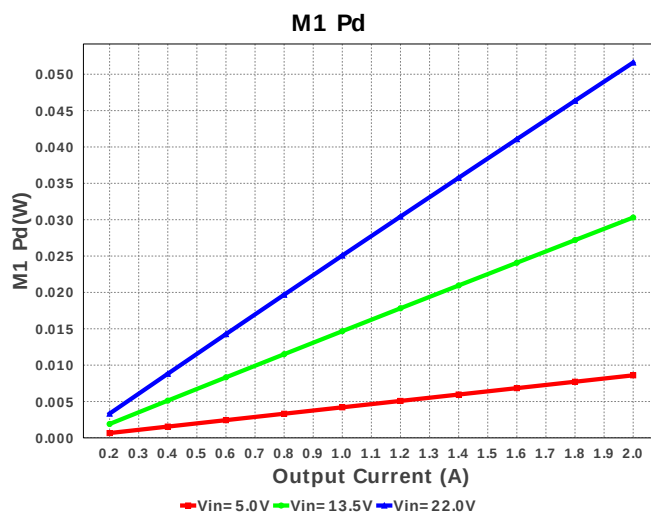
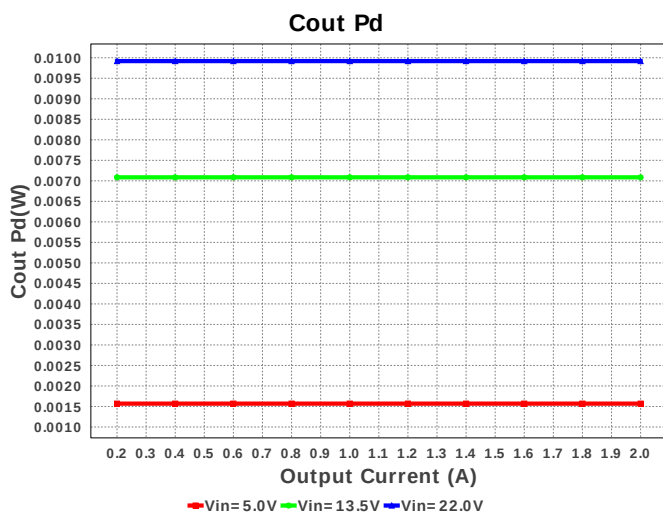
Electrical BOM

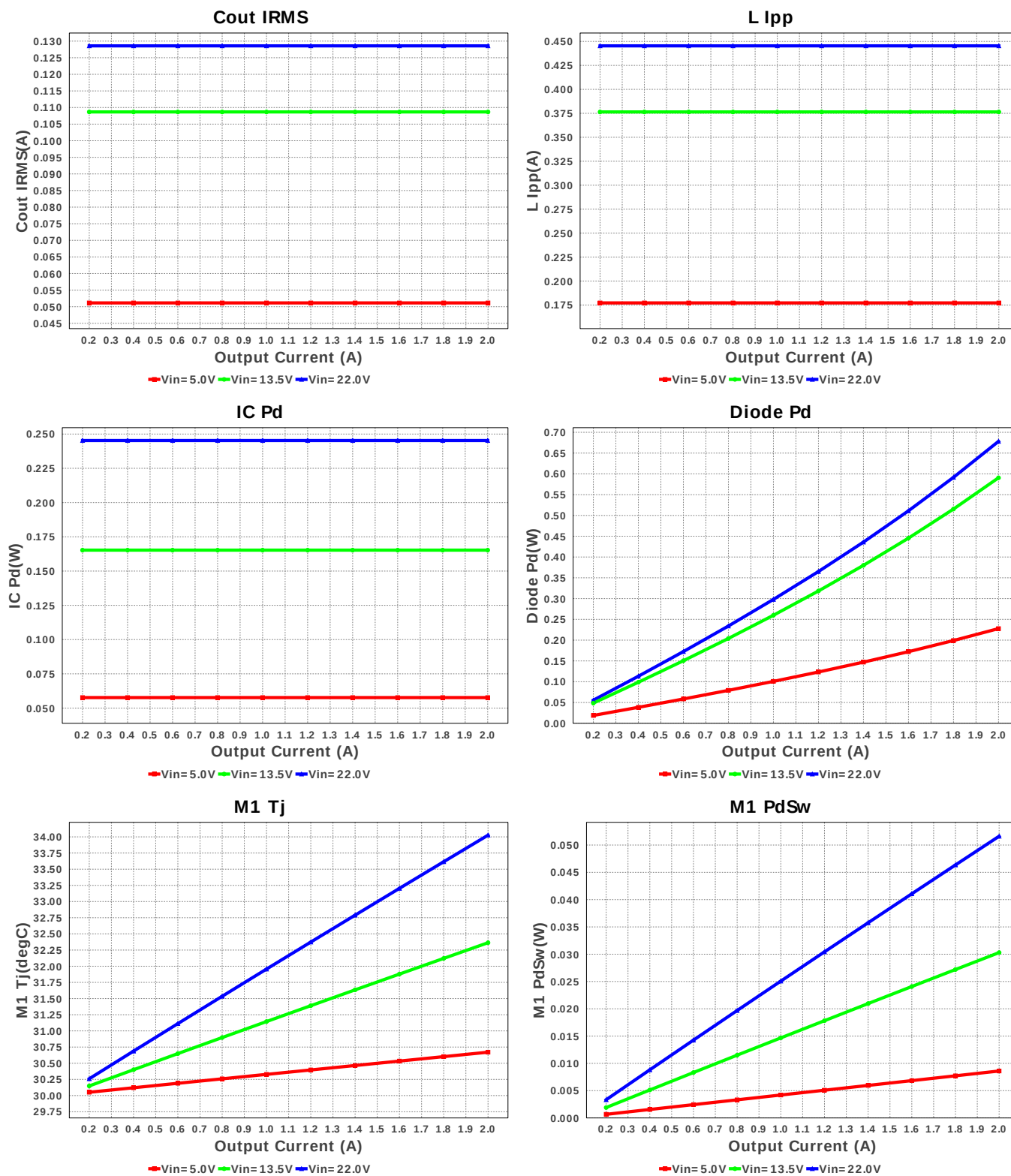
#	Name	Manufacturer	Part Number	Properties	Qty	Price	Footprint
1.	Cadj	Samsung Electro-Mechanics	CL21C102JBCNFNC Series= C0G/NP0	Cap= 1.0 nF VDC= 50.0 V IRMS= 0.0 A	1	\$0.01	 0805 7 mm ²
2.	Cff	Kemet	C0402C112J5GAC7867 Series= C0G/NP0	Cap= 1.1 nF VDC= 50.0 V IRMS= 0.0 A	1	\$0.09	 0402 3 mm ²
3.	Cin	MuRata	GRM31CR71H475KA12L Series= X7R	Cap= 4.7 µF ESR= 3.0 mOhm VDC= 50.0 V IRMS= 4.98 A	3	\$0.07	 1206 11 mm ²
4.	Cout	AVX	TPSA336K006R0600 Series= TPS	Cap= 33.0 µF ESR= 600.0 mOhm VDC= 6.3 V IRMS= 318.0 mA	1	\$0.13	 3216-18 11 mm ²
5.	Cvcc	AVX	0805YC474KAT2A Series= X7R	Cap= 470.0 nF ESR= 11.0 mOhm VDC= 16.0 V IRMS= 0.0 A	1	\$0.02	 0805 7 mm ²
6.	D1	Diodes Inc.	B340A-13-F	VF@Io= 500.0 mV VRRM= 40.0 V	1	\$0.11	 SMA 37 mm ²
7.	L1	TDK	VLP8040T-100M	L= 10.0 µH DCR= 38.0 mOhm	1	\$0.22	 VLP8040 113 mm ²
8.	M1	Fairchild Semiconductor	FDC5614P	VdsMax= -60.0 V IdsMax= -3.0 Amps	1	\$0.23	 SOT-23-6 15 mm ²
9.	Radj	Vishay-Dale	CRCW04021K05FKED Series= CRCW..e3	Res= 1.05 kOhm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	 0402 3 mm ²
10.	Rfb1	Yageo America	RC0603FR-075K6L Series= ?	Res= 5.6 kOhm Power= 100.0 mW Tolerance= 1.0%	1	\$0.01	 0603 5 mm ²

#	Name	Manufacturer	Part Number	Properties	Qty	Price	Footprint
11.	Rfb2	Vishay-Dale	CRCW040210K0FKED Series= CRCW..e3	Res= 10.0 kOhm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	 0402 3 mm²
12.	Rsns	Stackpole Electronics Inc	CSR1206FK10L0 Series= ?	Res= 10.0 mOhm Power= 500.0 mW Tolerance= 1.0%	1	\$0.11	 1206 11 mm²
13.	Rt	Vishay-Dale	CRCW040225K5FKED Series= CRCW..e3	Res= 25.5 kOhm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	 0402 3 mm²
14.	U1	Texas Instruments	LM5085MY/NOPB	Switcher	1	\$0.85	 MUY08A 24 mm²









Operating Values

#	Name	Value	Category	Description
1.	Cin IRMS	759.085 mA	Current	Input capacitor RMS ripple current
2.	Cout IRMS	128.573 mA	Current	Output capacitor RMS ripple current
3.	Iin Avg	373.44 mA	Current	Average input current
4.	L Ipp	445.39 mA	Current	Peak-to-peak inductor ripple current
5.	SW Ipk	2.223 A	Current	Peak switch current
6.	BOM Count	16	General	Total Design BOM count
7.	FootPrint	274.0 mm ²	General	Total Foot Print Area of BOM components
8.	Frequency	547.171 kHz	General	Switching frequency
9.	IC Tolerance	25.0 mV	General	IC Feedback Tolerance
10.	Pout	7.0 W	General	Total output power
11.	Total BOM	\$2.02	General	Total BOM Cost

#	Name	Value	Category	Description
12.	D1 Tj	97.819 degC	Op_Point	D1 junction temperature
13.	Vout Actual	3.482 V	Op_Point	Vout Actual calculated based on selected voltage divider resistors
14.	Vout OP	3.5 V	Op_Point	Operational Output Voltage
15.	Duty Cycle	17.45 %	Op_point	Duty cycle
16.	Efficiency	85.204 %	Op_point	Steady state efficiency
17.	IC Tj	41.283 degC	Op_point	IC junction temperature
18.	ICThetaJA	46.0 degC/W	Op_point	IC junction-to-ambient thermal resistance
19.	IOUT_OP	2.0 A	Op_point	Iout operating point
20.	M1 Tj	34.026 degC	Op_point	M1 MOSFET junction temperature
21.	VIN_OP	22.0 V	Op_point	Vin operating point
22.	Vout p-p	267.252 mV	Op_point	Peak-to-peak output ripple voltage
23.	Cin Pd	576.21 μ W	Power	Input capacitor power dissipation
24.	Cout Pd	9.919 mW	Power	Output capacitor power dissipation
25.	Diode Pd	678.188 mW	Power	Diode power dissipation
26.	IC Pd	245.28 mW	Power	IC power dissipation
27.	L Pd	190.0 mW	Power	Inductor power dissipation
28.	M1 Pd	51.614 mW	Power	M1 MOSFET total power dissipation
29.	M1 PdCond	0.0 W	Power	M1 MOSFET conduction losses
30.	M1 PdSw	51.614 mW	Power	M1 MOSFET switching losses
31.	Total Pd	1.216 W	Power	Total Power Dissipation
32.	Vout Tolerance	3.321 %		Vout Tolerance based on IC Tolerance (no load) and voltage divider resistors if applicable

Design Inputs

#	Name	Value	Description
1.	Iout	2.0	Maximum Output Current
2.	VinMax	22.0	Maximum input voltage
3.	VinMin	5.0	Minimum input voltage
4.	Vout	3.5	Output Voltage
5.	base_pn	LM5085	Base Product Number
6.	source	DC	Input Source Type
7.	Ta	30.0	Ambient temperature

Design Assistance

1. For a Constant On Time device to be stable, we need to provide a ripple at the feedback comparator. There are various methods to implement the ripple. Depending on the circuit complexity vs. the allowable ripple, we have three options to choose from. The simplest option, 'Low Complexity', would require only a high ESR cap at the output. This means that the BOM count will be small, but the output voltage ripple will be quite large. The 'optimal solution' would require a feed-forward cap in parallel with the upper feedback resistor to AC couple the ripple to the feedback node. This increases the BOM count slightly, but now we have more control over the output voltage ripple. If the output voltage requirement is very tight, then the best option is to go for the 'Low Output Ripple' solution. In this option we can go with very low ESR output caps and have very good control over the output voltage ripple

2. **LM5085 Product Folder** : <http://www.ti.com/product/LM5085> : contains the data sheet and other resources.

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